

Quad USB High-Side Power Switch

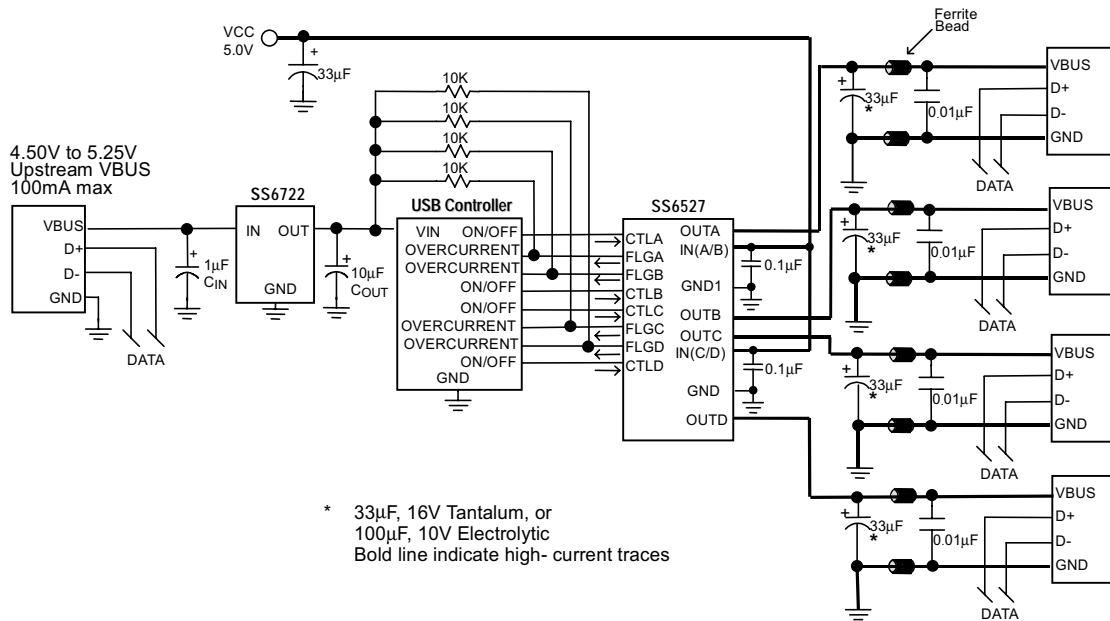
■ FEATURES

- 110mΩ (5V Input) High-Side MOSFET Switch.
- 500mA Continuous Load Current per Channel.
- 220µA Typical On-State Supply Current.
- 1µA Typical Off-State Supply Current.
- Current-Limit / Short Circuit Protection.
- Thermal Shutdown Protection under Overcurrent Condition.
- Undervoltage Lockout Ensures that Switch is off at Start Up.
- Output can be Forced Higher than Input (Off-State).
- Open-Drain Fault Flag.
- Slow Turn ON and Fast Turn OFF.
- Enable Active-High or Active-Low.

■ APPLICATIONS

- USB Power Management.
- Hot Plug-In Power Supplies.
- Battery-Charger Circuit.

■ TYPICAL APPLICATION CIRCUIT



4-Port Self-Powered Hub

■ ORDERING INFORMATION

SS6527-XCXXX

- PACKING TYPE
TR: TAPE & REEL
TB: TUBE
- PACKAGING TYPE
N: PLASTIC DIP
S: SMALL OUTLINE
- CONTROL POLARITY
0: Active Low
1: Active High

 Example: **SS6527-0COTR**

→ Active Low Version, in SO-16 Package

& Taping & Reel Packing Type

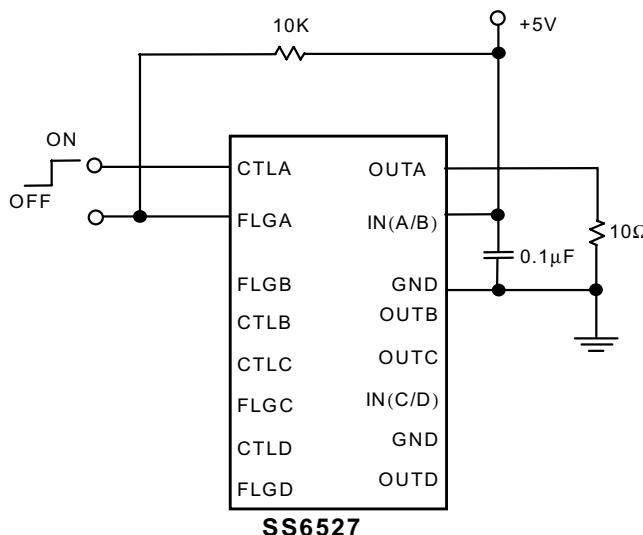
(CN is not available in TR type.)

| PIN CONFIGURATION | |
|-------------------|--------------|
| SO-16 TOP VIEW | |
| CTLA | 1 16 OUTA |
| FLGA | 2 15 IN(A/B) |
| FLGB | 3 14 GND |
| CTLB | 4 13 OUTB |
| CTLC | 5 12 OUTC |
| FLGC | 6 11 IN(C/D) |
| FLGD | 7 10 GND |
| CTLD | 8 9 OUTD |

■ ABSOLUTE MAXIMUM RATINGS

| | |
|--|---------------|
| Supply Voltage (V_{IN}) | 7.0V |
| Fault Flag Voltage (V_{FLG}) | 7.0V |
| Fault Flag Current (I_{FLG}) | 50mA |
| Control Input (V_{CTL}) | -0.3V ~ 15V |
| Operating Temperature Range | -20°C ~ 80°C |
| Storage Temperature Range | -65°C ~ 150°C |

■ TEST CIRCUIT



(For output reference only)

■ ELECTRICAL CHARACTERISTICS ($V_{IN} = 5V$, $T_A = 25^\circ C$, unless otherwise specified.)

| PARAMETERS | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|------------------------------------|--|------|------|------|------------------|
| Supply Current | $V_{CTL} = \text{Logic "0"}, \text{OUT}=\text{Open}$ | | 1.50 | 10 | μA |
| | $V_{CTL} = \text{Logic "1}, \text{OUT}=\text{Open}$ | | 220 | 320 | |
| Control Input Voltage | $V_{CTL} = \text{Logic "0"}$ | | | 0.8 | V |
| | $V_{CTL} = \text{Logic "1"}$ | 2.4 | | | |
| Control Input Current | $V_{CTL} = \text{Logic "0"}$ | | 0.01 | 1 | μA |
| | $V_{CTL} = \text{Logic "1"}$ | | 0.01 | 1 | |
| Control Input Capacitance | | | 1 | | pF |
| Output MOSFET Resistance | | | 110 | 150 | $\text{m}\Omega$ |
| Output Turn-On Rise Delay | $R_L = 10\Omega$ each Output | | 100 | | μs |
| Output Turn-On Rise Time | $R_L = 10\Omega$ each Output | | 1000 | 2500 | μs |
| Output Turn-Off Delay | $R_L = 10\Omega$ each Output | | 0.8 | 20 | μs |
| Output Turn-Off Fall Time | $R_L = 10\Omega$ each Output | | 0.7 | 20 | μs |
| Output Leakage Current | | | | 10 | μA |
| Current Limit Threshold | | 0.6 | 1.0 | 1.25 | A |
| Overtemperature Shutdown Threshold | T_J Increasing | | 135 | | $^\circ\text{C}$ |
| | T_J Decreasing | | 125 | | |
| Error Flag Output Resistance | $V_{IN} = 5V, I_L = 10 \text{ mA}$ | | 10 | 25 | Ω |
| | $V_{IN} = 3.3V, I_L = 10 \text{ mA}$ | | 15 | 40 | |
| Error Flag Off Current | $V_{FLG} = 5V$ | | 0.01 | 1 | μA |
| UVLO Threshold | V_{IN} Increasing | | 2.6 | | V |
| | V_{IN} Decreasing | | 2.4 | | |

■ TYPICAL PERFORMANCE CHARACTERISTICS

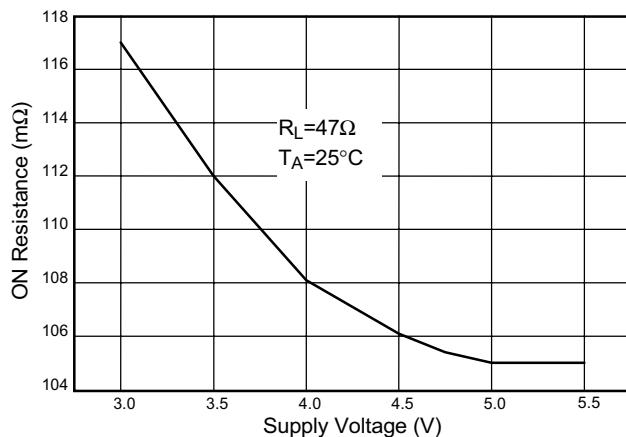


Fig. 1 ON Resistance vs. Supply Voltage

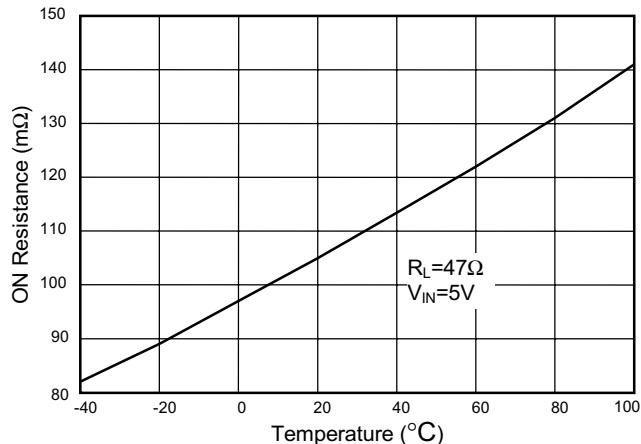


Fig. 2 Output On Resistance vs. Temperature

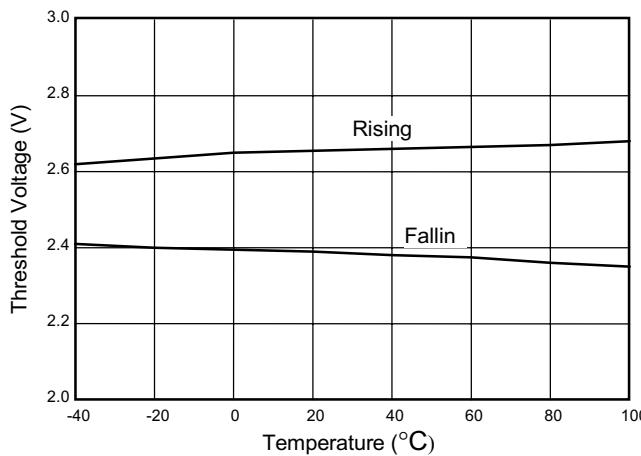


Fig. 3 UVLO Threshold Voltage vs. Temperature

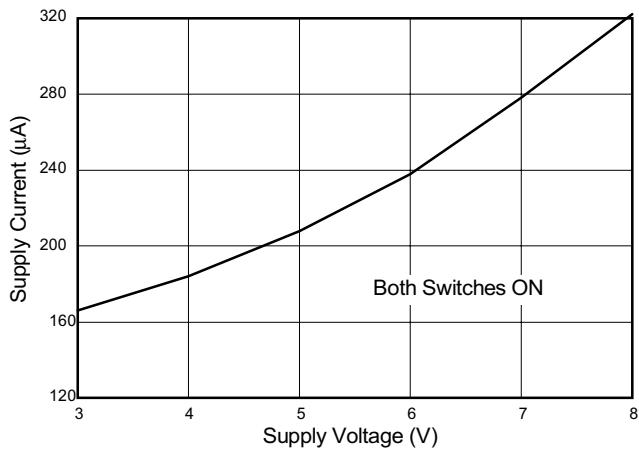


Fig. 4 ON-State Supply Current vs. Supply Voltage

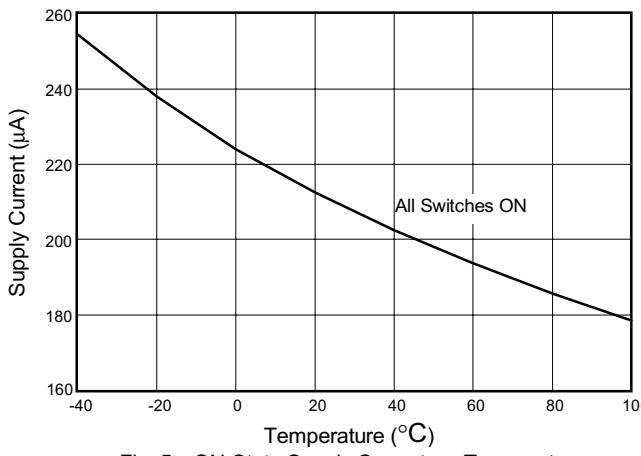


Fig. 5 ON-State Supply Current vs. Temperature

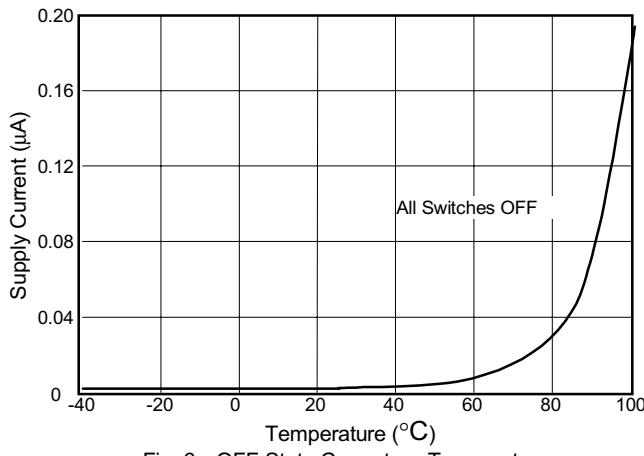


Fig. 6 OFF-State Current vs. Temperature

■ TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

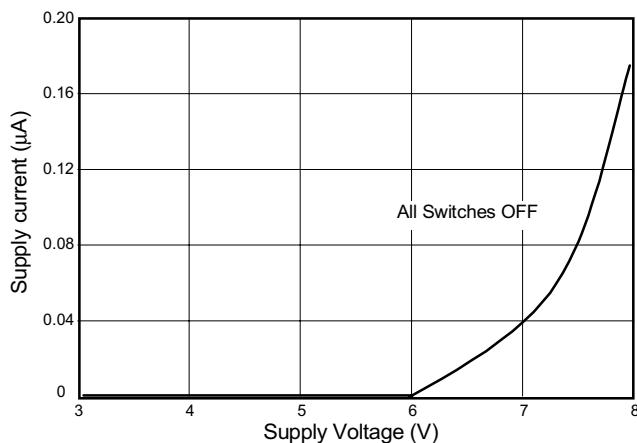


Fig. 7 OFF-State Current vs. Supply Voltage

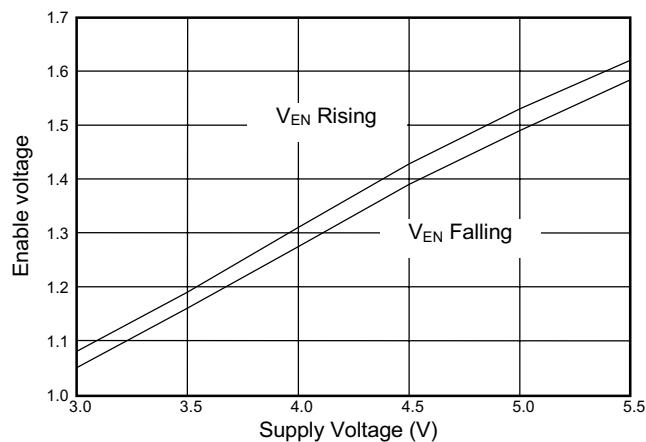


Fig. 8 Control Threshold vs. Supply Voltage

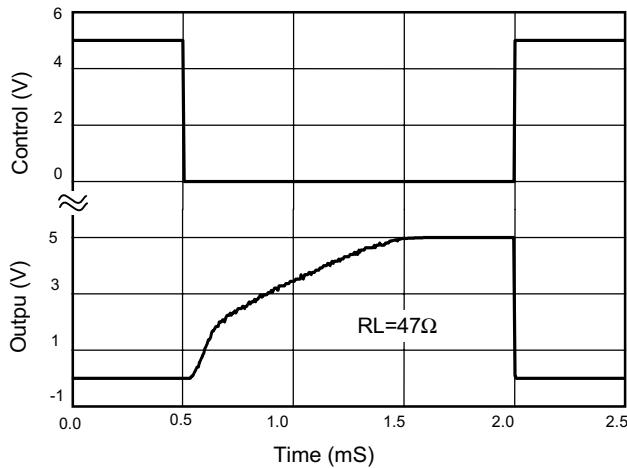
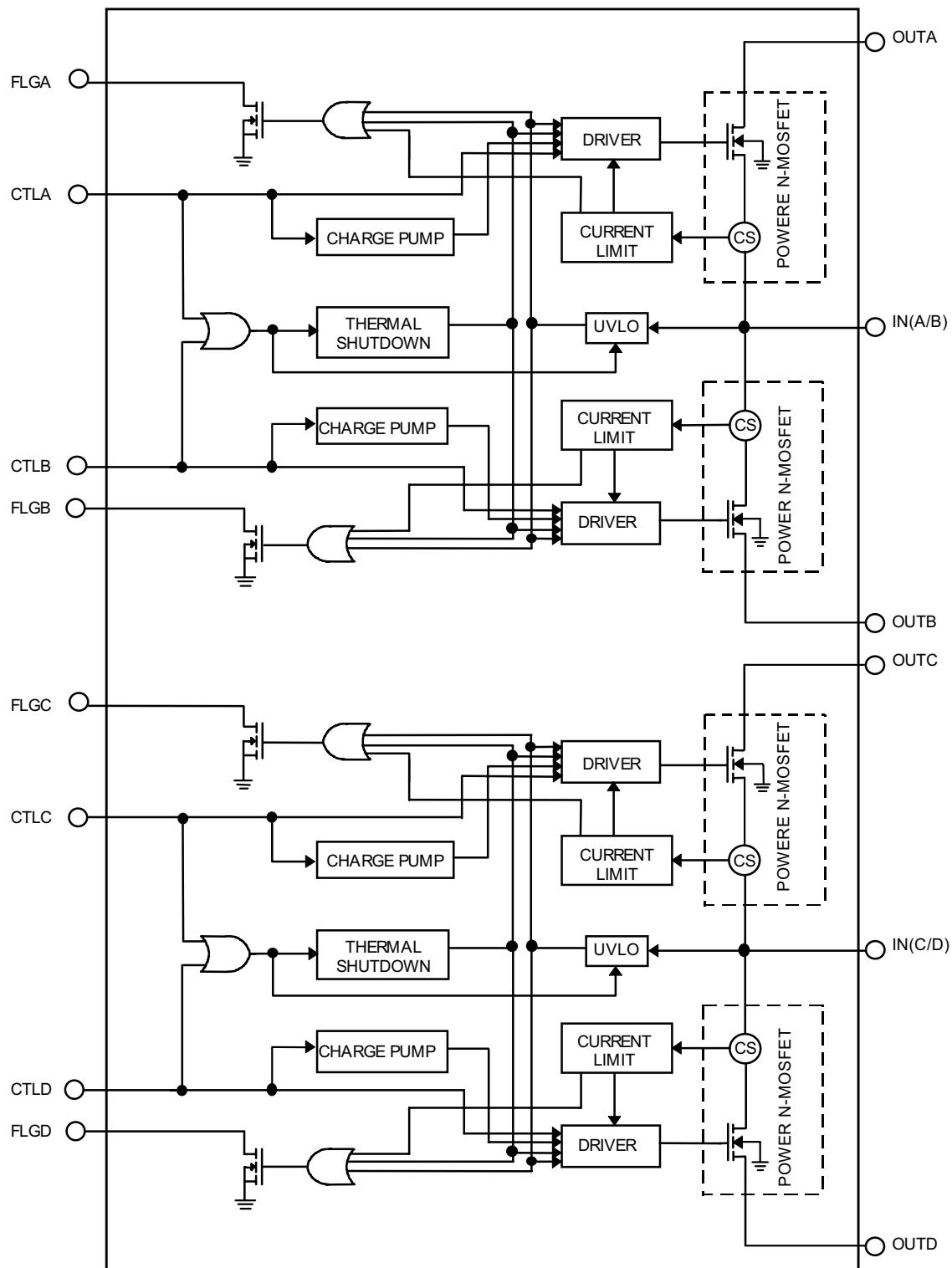


Fig. 9 Turn-On, Turn-Off Characteristics

■ BLOCK DIAGRAM



■ PIN DESCRIPTIONS

PIN 1(5):CTLA(C)- TTL compatible control input. It controls the turn-on/turn-off of channel A(C) MOSFET. Active High for SS6527-1 and active low for SS6527-0.

PIN 2(6):FLGA(C)- An active-low and open-drain fault flag output for channel A. It can indicate current limit if CTLA(C) is active. In normal mode operation (CTLA(C) or/and CLTB(D) is active), it also can indicate thermal shutdown or undervoltage.

PIN 3(7):FLGB(D)- An active-low and open-drain fault flag output for channel B(D). It can indicate current limit if CLTB(D) is active. In normal mode operation (CLTB(D) or/and CLTA(C) is active), it also can indicate

thermal shutdown or undervoltage.

PIN 4(8):CLTB(D)-TTL compatible control input. It controls the turn-on/turn-off of channel B(D) MOSFET. Active High for SS6527-1 and active low for SS6527-0.

PIN9(13):OUTD(B)-Channel D(B) MOSFE switch output.

PIN 10,14:GND - Chip power return, Connect both pins to ground.

PIN 11:IN(C/D) - Channel C AND D power supply input.

PIN12(16):OUTC(A) -Channel C(A) MOSFET switch output.

PIN15: IN(A/B) - Channel A and B power supply input.

■ APPLICATION INFORMATIONS

● Error Flag

An open-drained output of an N-channel MOSFET, the FLG output is pulled low to signal the following fault conditions: input undervoltage, output current limit, and thermal shutdown.

● Current Limit

The current limit threshold is preset internally. It protects the output MOSFET switches from damage due to undesirable short circuit conditions or excess inrush current often encountered during hot plug-in. The low limit of the current limit threshold of the SS6527 allows a minimum current of 0.5A through the MOSFET switches. A current limit condition will signal the error flag.

● Thermal Shutdown

When the chip temperature exceeds 135°C for any reason other than overcurrent fault of either one of the four MOSFET switches, the thermal shutdown function turns off all MOSFET switches and signal the error flag. A hysteresis of 10°C prevents the MOSFETs from turning back on until the chip temperature drops to below 125°C. However, if thermal shutdown is triggered by chip temperature rise due to overcurrent fault condition of either one of the MOSFET switches, the thermal shutdown function will only turn off the switch that is in overcurrent condition and the other switch can still remain its normal operation. In other words, the thermal shutdown function of the four switches is independent of each other in the case of overcurrent fault.

● Supply Filtering

A 0.1uF to 1uF bypass capacitor from IN to GND, located near the device, is strongly recommended to control supply transients. Without a bypass capacitor, an output short may cause sufficient ringing on the input (from supply lead inductance) to damage internal control circuitry.

● Transient Droop Requirements

USB support dynamic attachment (hot plug-in) of peripherals. A current surge is caused by the input capacitance of downstream device. Ferrite beads are recommended in series with all power and ground connector pins. Ferrite beads reduce EMI

and limit the inrush current during hot-attachment by filtering high-frequency signals.

● Short Circuit Transient

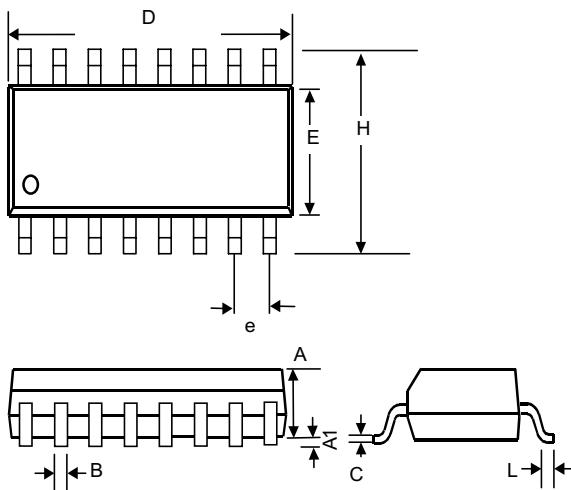
Bulk capacitance provides the short-term transient current needed during a hot-attachment event. With a 33uF, 16V tantalum or 100uF, 10V electrolytic capacitor mounted close to downstream connector per port should provide transient drop protection.

● Printed Circuit Layout

The power circuitry of USB printed circuit boards requires a customized layout to maximize thermal dissipation and to minimize voltage drop and EMI.

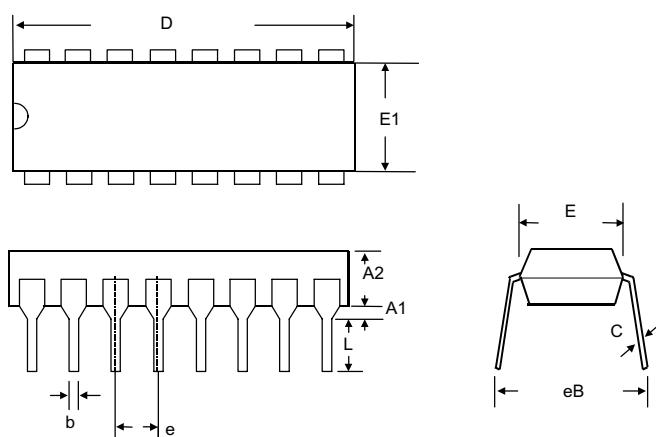
■ PHYSICAL DIMENSIONS

● 16 LEAD PLASTIC SO (150 mil) (unit: mm)



| SYMBOL | MIN | MAX |
|--------|------------|-------|
| A | 1.35 | 1.75 |
| A1 | 0.10 | 0.25 |
| B | 0.33 | 0.51 |
| C | 0.19 | 0.25 |
| D | 9.80 | 10.00 |
| E | 3.80 | 4.00 |
| e | 1.27 (TYP) | |
| H | 5.80 | 6.20 |
| L | 0.40 | 1.27 |

- 16 LEAD PLASTIC DIP (unit: mm)



| SYMBOL | MIN | MAX |
|--------|-----------|-------|
| A1 | 0.381 | — |
| A2 | 2.92 | 4.96 |
| b | 0.35 | 0.56 |
| C | 0.20 | 0.36 |
| D | 18.66 | 19.69 |
| E | 7.62 | 8.26 |
| E1 | 6.09 | 7.12 |
| e | 2.54(TYP) | — |
| eB | — | 10.92 |
| L | 2.92 | 3.81 |

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